

128K '8 CMOS FLASH MEMORY

GENERAL DESCRIPTION

The W29C011A is a 1-megabit, 5-volt only CMOS flash memory organized as $128K \times 8$ bits. The device can be programmed and erased in-system with a standard 5V power supply. A 12-volt VPP is not required. The unique cell architecture of the W29C011A results in fast program/erase operations with extremely low current consumption (compared to other comparable 5-volt flash memory products). The device can also be programmed and erased using standard EPROM programmers.

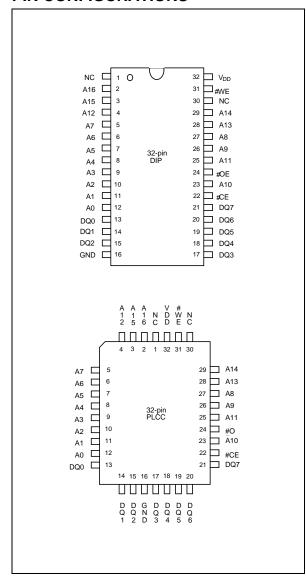
FEATURES

- Single 5-volt program and erase operations
- · Fast page-write operations
 - 128 bytes per page
 - Page program cycle: 10 mS (max.)
 - Effective byte-program cycle time: 39 μ S
 - Software-protected data write
- Fast chip-erase operation: 50 mS
- · Read access time: 150 nS
- Page program/erase cycles: 1,000
- Ten-year data retention
- Software and hardware data protection

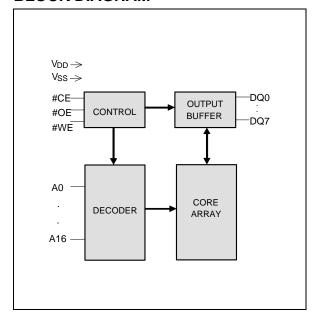
- Low power consumption
 - Active current: 25 mA (typ.)
 - Standby current: 20 μA (typ.)
- Automatic program timing with internal VPP generation
- End of program detection
 - Toggle bit
 - Data polling
- · Latched address and data
- TTL compatible I/O
- JEDEC standard byte-wide pinouts
- Available packages: 32-pin 600 mil DIP, 450 mil SOP and PLCC



PIN CONFIGURATIONS



BLOCK DIAGRAM



PIN DESCRIPTION

| SYMBOL | PIN NAME |
|-----------|---------------------|
| A0 – A16 | Address Inputs |
| DQ0 – DQ7 | Data Inputs/Outputs |
| #CE | Chip Enable |
| #OE | Output Enable |
| #WE | Write Enable |
| Vdd | Power Supply |
| GND | Ground |
| NC | No Connection |



FUNCTIONAL DESCRIPTION

Read Mode

The read operation of the W29C011A is controlled by #CE and #OE, both of which have to be low for the host to obtain data from the outputs. #CE is used for device selection. When #CE is high, the chip is de-selected and only standby power will be consumed. #OE is the output control and is used to gate data from the output pins. The data bus is in high impedance state when either #CE or #OE is high. Refer to the timing waveforms for further details.

Page Write Mode

The W29C011A is programmed on a page basis. Every page contains 128 bytes of data. If a byte of data within a page is to be changed, data for the entire page must be loaded into the device. Any byte that is not loaded will be erased to "FFh" during programming of the page.

The write operation is initiated by forcing #CE and #WE low and #OE high. The write procedure consists of two steps. Step 1 is the byte-load cycle, in which the host writes to the page buffer of the device. Step 2 is an internal programming cycle, during which the data in the page buffers are simultaneously written into the memory array for non-volatile storage.

During the byte-load cycle, the addresses are latched by the falling edge of either #CE or #WE, whichever occurs last. The data are latched by the rising edge of either #CE or #WE, whichever occurs first. If the host loads a second byte into the page buffer within a byte-load cycle time (TBLc) of 200 μ S, after the initial byte-load cycle, the W29C011A will stay in the page load cycle. Additional bytes can then be loaded consecutively. The page load cycle will be terminated and the internal programming cycle will start if no additional byte is loaded into the page buffer within 300 μ S (TBLCO) from the last byte-load cycle, i.e., there is no subsequent #WE high-to-low transition after the last rising edge of #WE. A7 to A16 specify the page address. All bytes that are loaded into the page buffer must have the same page address. A0 to A6 specify the byte address within the page. The bytes may be loaded in any order; sequential loading is not required.

In the internal programming cycle, all data in the page buffers, i.e., 128 bytes of data, are written simultaneously into the memory array. Before the completion of the internal programming cycle, the host is free to perform other tasks such as fetching data from other locations in the system to prepare to write the next page.

Software-protected Data Write

The device provides a JEDEC-approved software-protected data write. Once this scheme is enabled, any write operation requires a series of three-byte program commands (with specific data to a specific address) to be performed before the data load operation. The three-byte load command sequence begins the page load cycle, without which the write operation will not be activated. This write scheme provides optimal protection against inadvertent write cycles, such as cycles triggered by noise during system power-up and power-down.

The W29C011A is shipped with the software data protection enabled. To enable the software data protection scheme, perform the three-byte command cycle at the beginning of a page load cycle. The device will then enter the software data protection mode, and any subsequent write operation must be preceded by the three-byte program command cycle.



Hardware Data Protection

The integrity of the data stored in the W29C011A is also hardware protected in the following ways:

- (1) Noise/Glitch Protection: A #WE pulse of less than 15 nS in duration will not initiate a write cycle.
- (2) VDD Power Up/Down Detection: The programming and read operation are inhibited when VDD is less than 3.8V.
- (3) Write Inhibit Mode: Forcing #OE low, #CE high, or #WE high will inhibit the write operation. This prevents inadvertent writes during power-up or power-down periods.

Data Polling (DQ7)-Write Status Detection

The W29C011A includes a data polling feature to indicate the end of a programming cycle. When the W29C011A is in the internal programming cycle, any attempt to read DQ7 of the last byte loaded during the page/byte-load cycle will receive the complement of the true data. Once the programming cycle is completed. DQ7 will show the true data.

Toggle Bit (DQ6)-Write Status Detection

In addition to data polling, the W29C011A provides another method for determining the end of a program cycle. During the internal programming cycle, any consecutive attempts to read DQ6 will produce alternating 0's and 1's. When the programming cycle is completed, this toggling between 0's and 1's will stop. The device is then ready for the next operation.

5-Volt-Only Software Chip Erase

The chip-erase mode can be initiated by a six-byte command sequence. After the command loading cycles, the device enters the internal chip erase mode, which is automatically timed and will be completed in 50 mS. The host system is not required to provide any control or timing during this operation.

Product Identification

The product ID operation outputs the manufacturer code and device code. Programming equipment automatically matches the device with its proper erase and programming algorithms.

The manufacturer and device codes can be accessed by software or hardware operation. In the software access mode, a six-byte command sequence can be used to access the product ID. A read from address 0000H outputs the manufacturer code (DAh). A read from address 0001H outputs the device code (C1h). The product ID operation can be terminated by a three-byte command sequence.

In the hardware access mode, access to the product ID is activated by forcing #CE and #OE low, #WE high, and raising A9 to 12 volts.

Note: The hardware SID read function is not included in all parts; please refer to Ordering Information for details.



TABLE OF OPERATING MODES

Operating Mode Selection

Operating Range = 0 to 70° C (Ambient Temperature), VDD = 5V \pm 10 %, Vss = 0V, VHH = 12V

| MODE | | | | PINS | |
|----------------------------|-----|-----|-----|---------------------------------------|-------------------------------|
| | #CE | #OE | #WE | ADDRESS | DQ. |
| Read | VIL | VIL | VIH | Ain | Dout |
| Write | VIL | ViH | VIL | Ain | Din |
| Standby | VIH | Х | Х | X | High Z |
| Write Inhibit | Χ | VIL | Х | X | High Z/Dout |
| | Х | Х | ViH | X | High Z/Dout |
| Output Disable | Χ | VIH | Х | X | High Z |
| 5-Volt Software Chip Erase | VIL | VIH | VIL | AIN | DIN |
| Product ID | VIL | VIL | VIH | A0 = VIL; A1 - A16 = VIL; A9 = VHH | Manufacturer Code DA (Hex) |
| | VIL | VIL | VIH | A0 = VIH; A1 - A16 = VIL; A9 = VHH | Device Code C1 (Hex) |

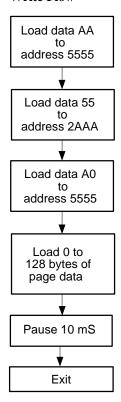


Command Codes for Software Data Protection Write

| BYTE SEQUENCE | ADDRESS | DATA |
|---------------|---------|------|
| 0 Write | 5555H | AAH |
| 1 Write | 2AAAH | 55H |
| 2 Write | 5555H | A0H |

Software Data Protection Acquisition Flow

Software Data Protection Write Flow



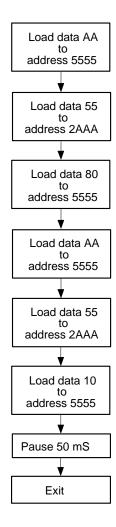
Notes for software program code: Data Format: DQ7 – DQ0 (Hex) Address Format: A14 – A0 (Hex)



COMMAND CODES FOR SOFTWARE CHIP ERASE

| BYTE SEQUENCE | ADDRESS | DATA |
|---------------|---------|------|
| 0 Write | 5555H | AAH |
| 1 Write | 2AAAH | 55H |
| 2 Write | 5555H | 80H |
| 3 Write | 5555H | AAH |
| 4 Write | 2AAAH | 55H |
| 5 Write | 5555H | 10H |

Software Chip Erase Acquisition Flow



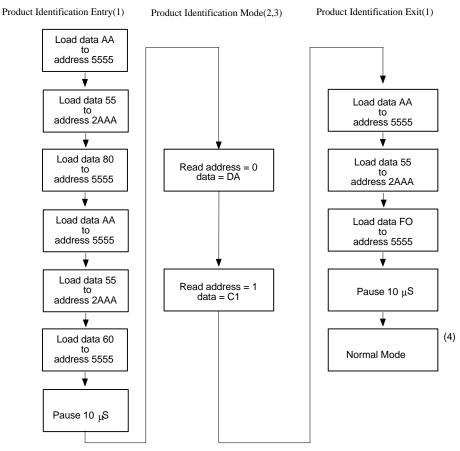
Notes for software chip erase: Data Format: DQ7 – DQ0 (Hex) Address Format: A14 – A0 (Hex)



Command Codes for Product Identification

| BYTE SEQUENCE | SOFTWARE PRODUCT IDENTIFICATION ENTRY | | SOFTWARE PRODUCT IDENTIFICATION EXIT | | |
|---------------|---------------------------------------|-------|--------------------------------------|-------|--|
| | ADDRESS | DATA | ADDRESS | DATA | |
| 0 Write | 5555H | AAH | 5555H | AAH | |
| 1 Write | 2AAAH | 55H | 2AAAH | 55H | |
| 2 Write | 5555H | 80H | 5555H | F0H | |
| 3 Write | 5555H | AAH | - | - | |
| 4 Write | 2AAAH | 55H | - | - | |
| 5 Write | 5555H | 60H | - | - | |
| | Pause | 10 μS | Pause | 10 μS | |

Software Product Identification Acquisition Flow



Notes for software product identification:

- (1) Data format: DQ7 DQ0 (Hex); address format: A14 A0 (Hex).
- (2) A1 A16 = VIL; manufacture code is read for A0 = VIL; device code is read for A0 = VIH.
- (3) The device does not remain in identification mode if power down.
- (4) The device returns to standard operation mode.



DC CHARACTERISTICS

Absolute Maximum Ratings

| PARAMETER | RATING | UNIT |
|---|------------------|------|
| Power Supply Voltage to Vss Potential | -0.5 to +7.0 | V |
| Operating Temperature | 0 to +70 | °C |
| Storage Temperature | -65 to +150 | °C |
| D.C. Voltage on Any Pin to Ground Potential except #OE | -0.5 to VDD +1.0 | V |
| Transient Voltage (≥20 nS) on Any Pin to Ground Potential | -1.0 to VDD +1.0 | V |
| Voltage on #OE Pin to Ground Potential | -0.5 to 12.5 | V |

Note: Exposure to conditions beyond those listed under Absolute Maximum Ratings may adversely affect the life and reliability of the device.

Operating Characteristics

(VDD = $5.0V \pm 10\%$, Vss = 0V, Ta = 0 to 70° C)

| PARAMETER | SYM. | TEST CONDITIONS | | LIMITS | 3 | UNIT |
|---------------------------|------|---|------|--------|----------|------|
| | | | MIN. | TYP. | MAX. | |
| Power Supply Current | Icc | #CE = #OE = VIL, #WE = VIH, all I/Os open | - | - | 50 | mA |
| | | Address inputs = VIL/VIH, at f = 5 MHz | | | | |
| Standby VDD Current | ISB1 | #CE = VIH, all I/Os open | - | 2 | 3 | mA |
| (TTL input) | | Other inputs = VIL/VIH | | | | |
| Standby VDD Current | IsB2 | #CE = VDD -0.3V, all I/Os open | - | 20 | 100 | μΑ |
| (CMOS input) | | Other inputs = VDD -0.3V/GND | | | | |
| Input Leakage Current | llı | VIN = GND to VDD | - | - | 1 | μΑ |
| Output Leakage Current | llo | VIN = GND to VDD | - | - | 10 | μΑ |
| Input Low Voltage | VIL | - | -0.3 | - | 0.8 | V |
| Input High Voltage | VIH | - | 2.0 | - | VDD +0.5 | V |
| Output Low Voltage | Vol | IOL = 2.1 mA | - | - | 0.45 | V |
| Output High Voltage | Vон | IOH = -0.4 mA | 2.4 | - | - | V |

Power-up Timing

| PARAMETER | SYMBOL | TYPICAL | UNIT |
|-----------------------------|-----------|---------|------|
| Power-up to Read Operation | Tpu.READ | 100 | μS |
| Power-up to Write Operation | TPU.WRITE | 5 | mS |



CAPACITANCE

 $(VDD = 5.0V, TA = 25^{\circ} C, f = 1 MHz)$

| PARAMETER | SYMBOL | CONDITIONS | MAX. | UNIT |
|---------------------|--------|------------|------|------|
| I/O Pin Capacitance | CI/O | VI/O = 0V | 12 | pF |
| Input Capacitance | CIN | VIN = 0V | 6 | pF |

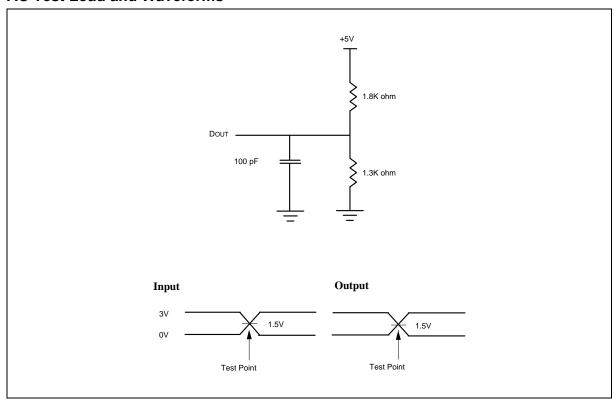
AC CHARACTERISTICS

AC Test Conditions

 $(VDD = 5V \pm 10\%)$

| PARAMETER | CONDITIONS |
|---------------------------|----------------------------|
| Input Pulse Levels | 0V/3V |
| Input Rise/Fall Time | 10 nS |
| Input/Output Timing Level | 1.5V/1.5V |
| Output Load | 1 TTL Gate and CL = 100 pF |

AC Test Load and Waveforms





Read Cycle Timing Parameters

(VDD = $5.0V \pm 10\%$, Vss = 0V, Ta = 0 to 70° C)

| PARAMETER | SYMBOL | W29C011A-15 | | UNIT |
|---------------------------------|--------|-------------|------|------|
| | | MIN. | MAX. | |
| Read Cycle Time | TRC | 150 | - | nS |
| Chip Enable Access Time | TCE | - | 150 | nS |
| Address Access Time | Таа | - | 150 | nS |
| Output Enable Access Time | TOE | - | 70 | nS |
| #CE Low to Active Output | TcLz | 0 | - | nS |
| #OE Low to Active Output | Tolz | 0 | - | nS |
| #CE High to High-Z Output | TCHZ | - | 45 | nS |
| #OE High to High-Z Output | Тонz | - | 45 | nS |
| Output Hold from Address change | Тон | 0 | - | nS |

Byte/Page-Write Cycle Timing Parameters

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|---------------------------------|--------|------|------|------|------|
| Write Cycle (erase and program) | Twc | - | - | 10 | mS |
| Address Setup Time | TAS | 0 | - | - | nS |
| Address Hold Time | Тан | 50 | - | - | nS |
| #WE and #CE Setup Time | Tcs | 0 | - | - | nS |
| #WE and #CE Hold Time | Тсн | 0 | - | - | nS |
| #OE High Setup Time | Toes | 10 | - | - | nS |
| #OE High Hold Time | Тоен | 10 | - | - | nS |
| #CE Pulse Width | Тср | 70 | - | - | nS |
| #WE Pulse Width | TWP | 70 | - | - | nS |
| #WE High Width | TWPH | 150 | - | - | nS |
| Data Setup Time | TDS | 50 | - | - | nS |
| Data Hold Time | TDH | 10 | - | - | nS |
| Byte Load Cycle Time | TBLC | 0.22 | - | 200 | μS |
| Byte Load Cycle Time-out | TBLCO | 300 | - | - | μS |

Note: All AC timing signals observe the following guidelines for determining setup and hold times: (a) High level signal's reference level is VIH and (b) low level signal's reference level is VIL.

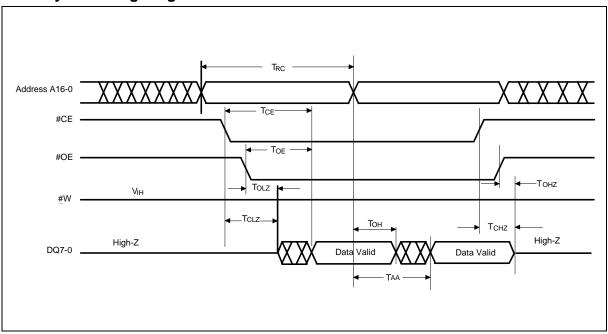


Data Polling and Toggle Bit Timing Parameters

| PARAMETER | SYMBOL | W29C011A-15 | | UNIT |
|----------------------------------|--------|-------------|------|------|
| | | MIN. | MAX. | |
| #OE to Data Polling Output Delay | TOEP | - | 70 | nS |
| #CE to Data Polling Output Delay | ТСЕР | - | 150 | nS |
| #OE to Toggle Bit Output Delay | TOET | - | 70 | nS |
| #CE to Toggle Bit Output Delay | ТСЕТ | - | 150 | nS |

TIMING WAVEFORMS

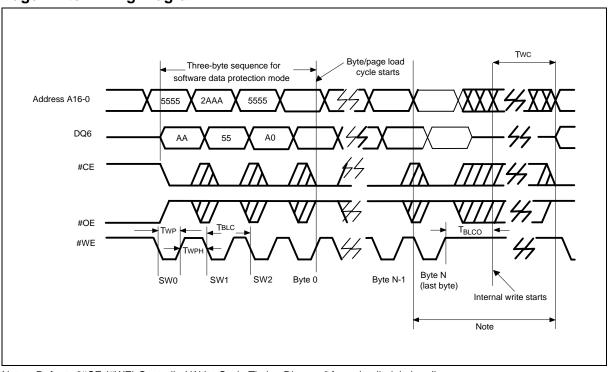
Read Cycle Timing Diagram





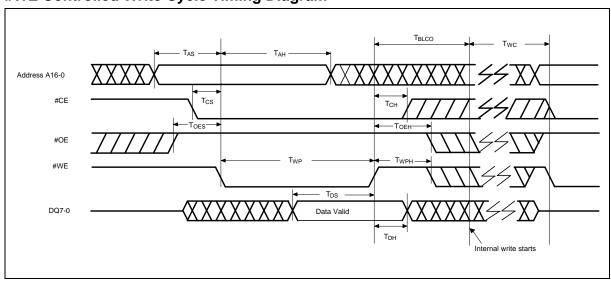
Timing Waveforms, continued

Page Write Timing Diagram



Notes: Refer to "#CE (#WE) Controlled Write Cycle Timing Diagram" for a detailed timing diagram.

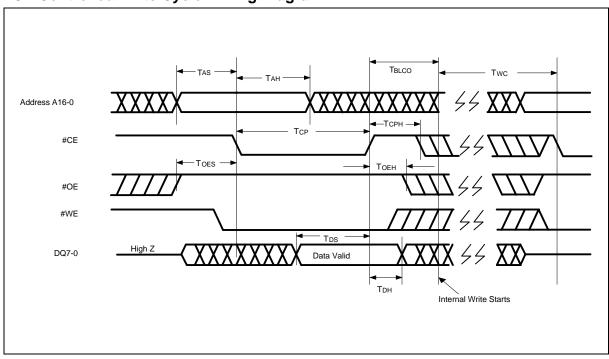
#WE Controlled Write Cycle Timing Diagram



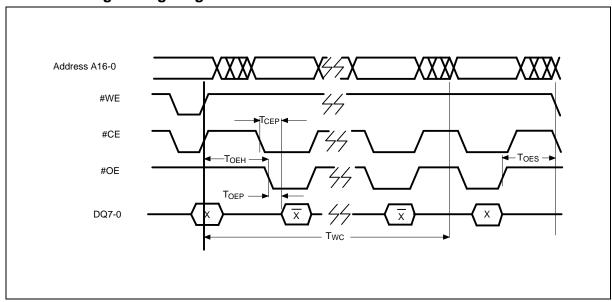


Timing Waveforms, continued

#CE Controlled Write Cycle Timing Diagram



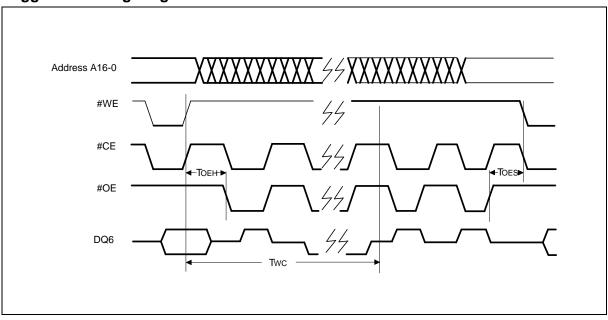
#DATA Polling Timing Diagram



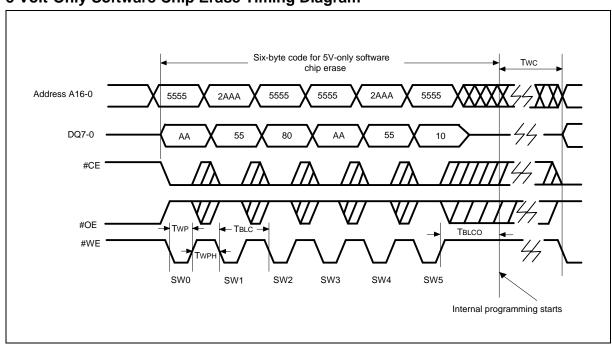


Timing Waveforms, continued

Toggle Bit Timing Diagram



5 Volt-Only Software Chip Erase Timing Diagram





ORDERING INFORMATION

| PART NO. | ACCESS TIME (nS) | POWER SUPPLY CURRENT MAX. (mA) | STANDBY VDD CURRENT MAX. (mA) | PACKAGE | HARDWARE SID READ FUNCTION |
|--------------|------------------------|--------------------------------------|-------------------------------------|-------------|----------------------------------|
| W29C011A-15 | 150 | 50 | 100 | 600 mil DIP | Υ |
| W29C011AS-15 | 150 | 50 | 100 | 450 mil SOP | Υ |
| W29C011AP-15 | 150 | 50 | 100 | 32-pin PLCC | Υ |
| W29C011A-15N | 150 | 50 | 100 | 600 mil DIP | N |
| W29C011AP15N | 150 | 50 | 100 | 32-pin PLCC | N |

Notes:

- 1. Winbond reserves the right to make changes to its products without prior notice.
- 2. Purchasers are responsible for performing appropriate quality assurance testing on products intended for use in applications where personal injury might occur as a consequence of product failure.
- 3. In Hardware SID Read column: Y = with SID read function; N = without SID read function.

HOW TO READ THE TOP MARKING

Example: The top marking of 32L-PLCC W29C011AP-15



1st line: winbond logo

2nd line: the part number: W29C011AP-15

3rd line: the lot number

4th line: the tracking code: <u>149 O B RA</u>

149: Packages made in '01, week 49

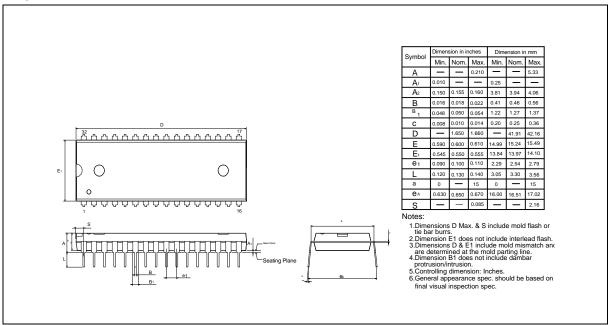
O: Assembly house ID: A means ASE, O means OSE, ...etc. B: IC revision; A means version A, B means version B, ...etc.

RA: Process code

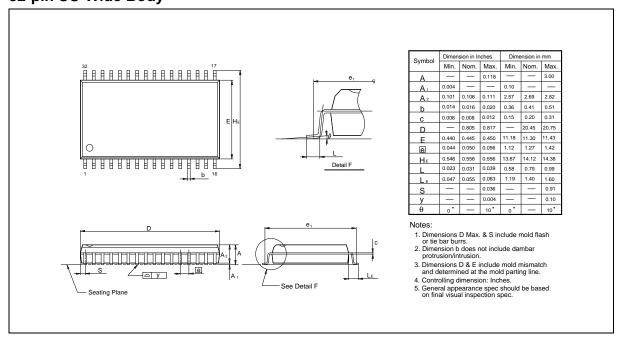


PACKAGE DIMENSIONS

32-pin P-DIP



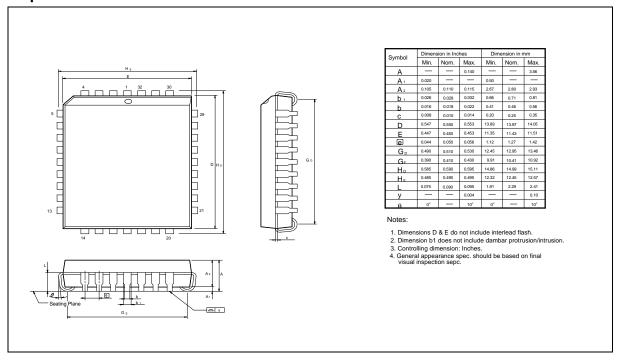
32-pin SO Wide Body





Package Dimensions, continued

32-pin PLCC





VERSION HISTORY

| VERSION | DATE | PAGE | DESCRIPTION |
|---------|---------------|-------|--|
| A1 | Dec. 1997 | | Initial Issued |
| A2 | Jan. 2001 | 10 | Modify VIH/VIL = 0V/3V and VOH/VOL = 1.5V/1.5V |
| | | 4, 16 | Add in Hardware SID Read function note |
| А3 | Jan. 31, 2002 | 4 | Modify Vcc Power Up/Down Detection in Hardware Data Protection |
| | | 16 | Add HOW TO READ THE TOP MARKING |



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